



Dual N-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

| $BV_{DSS} /$ BV_{DGS} | $R_{DS(ON)}$ (max) | $V_{GS(th)}$ (max) | $I_{D(ON)}$ (min) | Package |
|----------------------------|-----------------------|-----------------------|----------------------|----------|
| 240V | 6Ω | 2.0V | 1.0A | SO-8 |
| | | | | TD9944TG |

Features

- Dual N-channel devices
- Low threshold — 2.0V max.
- High input impedance
- Low input capacitance — 125 pF max.
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage

Applications

- Logic level interface — ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drive
- Analog switches
- General purpose line driver
- Telecom switches

Absolute Maximum Ratings

| | |
|-----------------------------------|-----------------|
| Drain-to-Source Voltage | BV_{DSS} |
| Drain-to-Gate Voltage | BV_{DGS} |
| Gate-to-Source Voltage | ± 20V |
| Operating and Storage Temperature | -55°C to +150°C |
| Soldering Temperature* | 300°C |

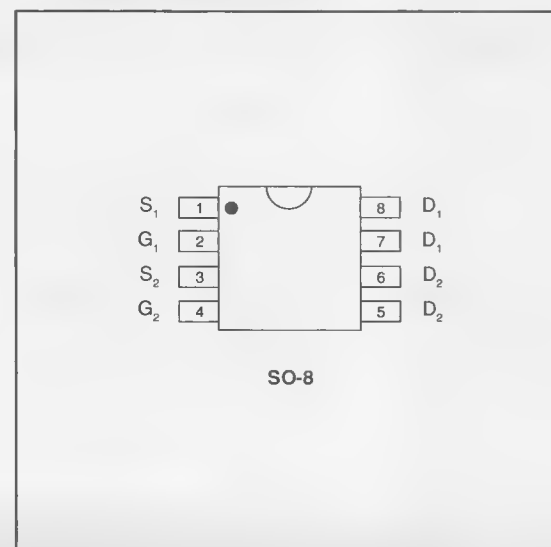
* Distance of 1.6 mm from case for 10 seconds.

Low Threshold DMOS Technology

These dual low threshold enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally induced secondary breakdown.

Supertex vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Pin Configuration



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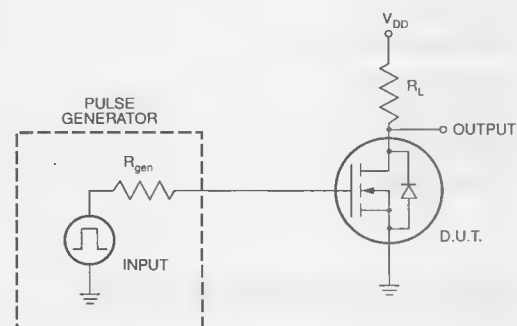
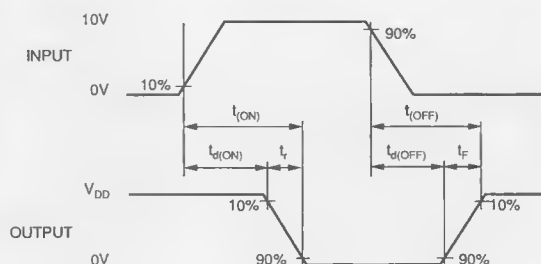
Electrical Characteristics (each device, @ 25°C unless otherwise specified)

| Symbol | Parameter | Min | Typ | Max | Unit | Conditions |
|---------------------|--|-----|-----|------|----------|--|
| BV_{DS} | Drain-to-Source Breakdown Voltage | 240 | | | V | $V_{GS} = 0, I_D = 2mA$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | 0.6 | | 2.0 | V | $V_{GS} = V_{DS}, I_D = 1mA$ |
| $\Delta V_{GS(th)}$ | Change in $V_{GS(th)}$ with Temperature | | | -5.0 | mV/°C | $V_{GS} = V_{DS}, I_D = 1mA$ |
| I_{GSS} | Gate Body Leakage | | | 100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| I_{DSS} | Zero Gate Voltage Drain Current | | | 10 | μA | $V_{GS} = 0, V_{DS} = \text{Max Rating}$ |
| | | | | 1.0 | mA | $V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ C$ |
| $I_{D(ON)}$ | ON-State Drain Current | 0.5 | 1.9 | | A | $V_{GS} = 4.5V, V_{DS} = 25V$ |
| | | 1.0 | 2.8 | | | $V_{GS} = 10V, V_{DS} = 25V$ |
| $R_{DS(ON)}$ | Static Drain-to-Source ON-State Resistance | | 4.0 | 6.0 | Ω | $V_{GS} = 4.5V, I_D = 250mA$ |
| | | | 4.0 | 6.0 | | $V_{GS} = 10V, I_D = 0.5A$ |
| $\Delta R_{DS(ON)}$ | Change in $R_{DS(ON)}$ with Temperature | | | 1.4 | %/°C | $V_{GS} = 10V, I_D = 0.5A$ |
| G_{FS} | Forward Transconductance | 300 | 600 | | mS | $V_{DS} = 25V, I_D = 0.5A$ |
| C_{ISS} | Input Capacitance | | 65 | 125 | pF | $V_{GS} = 0, V_{DS} = 25V$ $f = 1 \text{ MHz}$ |
| C_{OSS} | Common Source Output Capacitance | | 35 | 70 | | |
| C_{RSS} | Reverse Transfer Capacitance | | 10 | 25 | | |
| $t_{d(ON)}$ | Turn-ON Delay Time | | | 10 | ns | $V_{DD} = 25V,$ $I_D = 1.0A,$ $R_{GEN} = 25\Omega$ |
| t_r | Rise Time | | | 10 | | |
| $t_{d(OFF)}$ | Turn-OFF Delay Time | | | 20 | | |
| t_f | Fall Time | | | 20 | | |
| V_{SD} | Diode Forward Voltage Drop | | | 1.8 | V | $V_{GS} = 0, I_{SD} = 1.0A$ |
| t_{rr} | Reverse Recovery Time | | 300 | | ns | $V_{GS} = 0, I_{SD} = 1.0A$ |

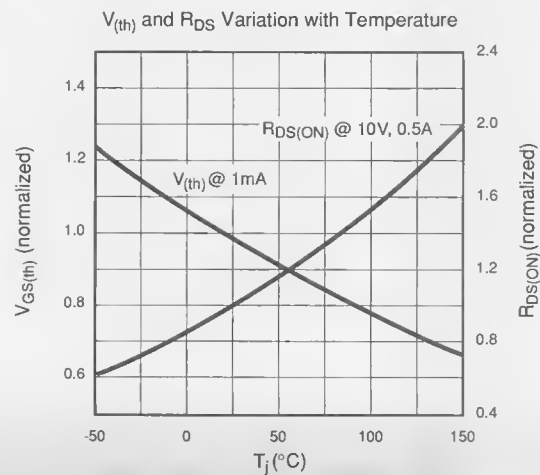
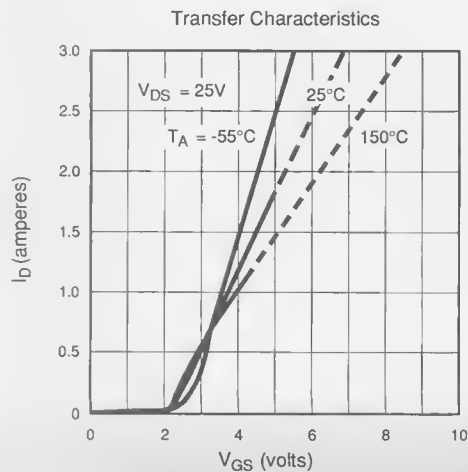
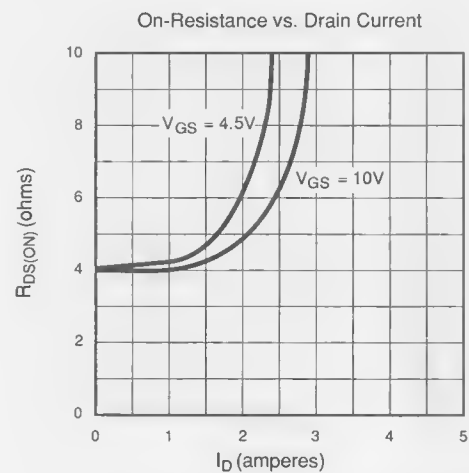
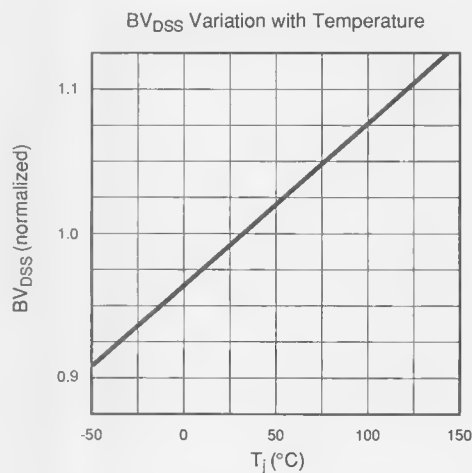
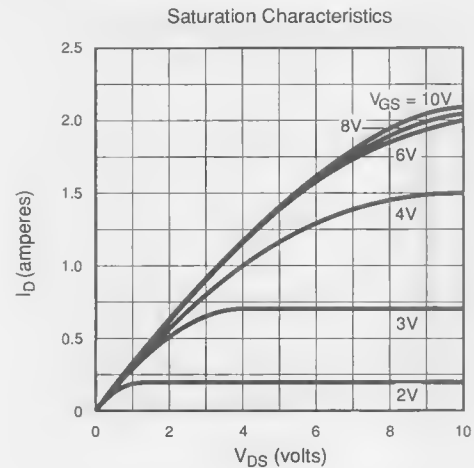
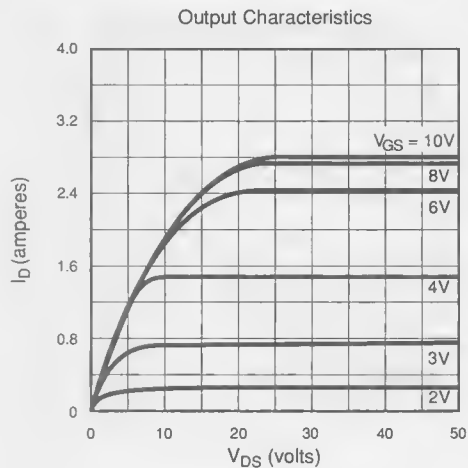
Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μ s pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit

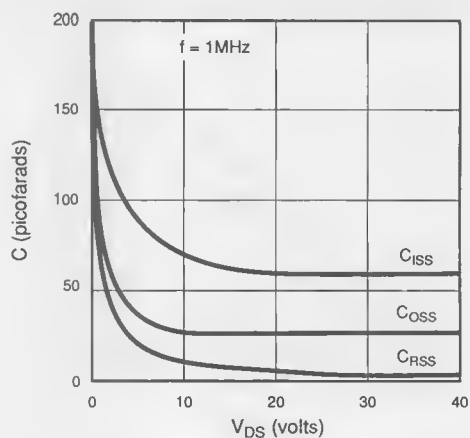


Typical Performance Curves

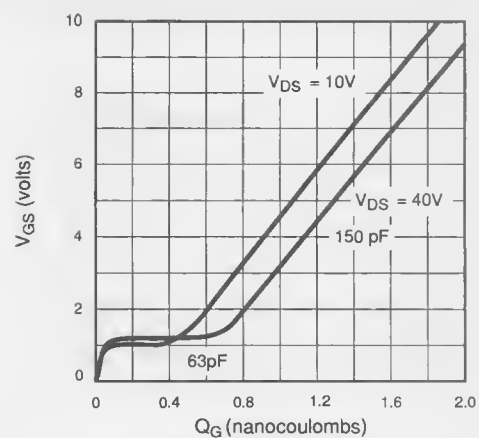


Typical Performance Curves

Capacitance vs. Drain-to-Source Voltage



Gate Drive Dynamic Characteristics



Transconductance vs. Drain Current

